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| HKIS | Hong Kong Institution of Science |

official use:

#### 2023 YOUNG SCIENTIST AWARDS

⎯ *APPLICATION FORM* ⎯

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| Name of applicant: *(underline Surname)* |  | | in Chinese *(as applicable)* |  |
|  |  | | | |
| Field of study: | Physical/Math science  Life science  Engineering science | | | |
|  |  | | | |
| Title of work: |  | | | |
|  |  | | | |
| Place where work is (was) performed: *(specify Institution & Department)* | |  | | |
|  | | | | |
| Contribution to the work (%): | | | | |
|  | | | | |
| Supervisor of the work: | | | | |
|  | | | | |
| Academic degree for which the work is (was) performed: | | | | |
|  | | | | |
| Date of graduation: | | | | |
|  | | | | |
| Present place of work (if applicable): | | | | |
|  | | | | |
|  | | | | |
| ***Extended summary of the work*** *(about 1,000 words)* | | | | |
| **List of relevant publications/patents** | | | | |
| **Statement highlighting the significance of the work** | | | | |

|  |  |  |  |
| --- | --- | --- | --- |
| Applicant’s address: |  | Email: |  |
| Tel: |  |

|  |  |  |
| --- | --- | --- |
|  |  |  |
| *Signature of applicant* |  | *Date* |